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AMENDMENT TRANSMITTAL LETTER

Docket No. 1155-0281PUS1

Application No.	Filing Date	Examiner	Art Unit
0/525,383-Conf. #5588	February 23, 2005	V. Chen	1773

plicant(s): Takeshi MINODA et al.

Invention: IN-MOLD COATING MOLDED ARTICLE AND PROCESS FOR PREPARING THE SAME

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

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	Claims Remaining After Amendment	Highes Numbe Previous Paid	r	Number Extra Claims Present		Rate	
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Marc S. Weiner Attorney Reg. N							
BIRCH, STEW/ 8110 Gatehous Suite 100 East P.O. Box 747 Falls Church, V (703) 205-8000	e Road irginia 22040-		H, LI	_P			



Docket No.: 1155-0281PUS1

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Takeshi MINODA, et al.

Conf.: 5588

Application No.: 10/525,383

Art Unit: 1773

Filed: February 22, 2005

Examiner: Vivian CHEN

For: IN-MOLD COATING MOLDED ARTICLE

AND PROCESS FOR PREPARING THE SAME

REQUEST FOR RECONSIDERATION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

Responsive to the Office Action of October 4, 2007, the following remarks are respectfully submitted in connection with the above-identified application.

This response includes:

Remarks; and

Translation of JP 2002-244160.